
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Nikhil Vishwanath Kelkar Attorney Docket No.: NSC1P300/P05882

Application No.: 10/824,903 Examiner: Zarneke, David A.

Filed: April 14, 2004 Group: 2891

Title: WAFER LEVEL PACKAGE DESIGN
THAT FACILITATES TRIMMING AND
TESTING

Confirmation No: 7593

AMENDMENT B

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

*Enter w/ RCE
RE 1/10/07*

Dear Sir:

In response to the Final Office Action mailed October 2, 2006, please amend the above-identified patent application as follows:

Amendments to the Claims are reflected in the listing of claims, which begin on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.